**Product data sheet** 

## 1. General description

Passivated, sensitive gate thyristors in a plastic envelope, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

### 2. Features and benefits

- · Sensitive gate
- Planar passivated for voltage ruggedness and reliability
- Direct triggering from low power drivers and logic ICs
- · Surface mountable package

## 3. Applications

- · General purpose switching and phase control
- · Ignition circuits, CDI for 2- and 3-wheelers
- · Motor control e.g. small kitchen appliances

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage			-	-	600	V
$I_{T(AV)}$	average on-state current	half sine wave; T <sub>mb</sub> ≤ 111 °C; <u>Fig. 1</u>		-	-	5	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>mb</sub> ≤ 111 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	-	8	Α
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 10 \text{ ms}$ ; Fig. 4; Fig. 5		-	-	75	А
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		-	-	82	Α
T <sub>j</sub>	junction temperature		[1]	-	-	125	°C
Static ch	aracteristics			'			,
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$		-	50	200	mA
Dynamic	characteristics						
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $R_{GK}$ = 100 Ω; $(V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 12		50	100	-	V/µs

<sup>[1]</sup> Operation above 110°C may require the use of a gate to cathode resistor of  $1k\Omega$  or less.

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode	}	A K G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

# 6. Ordering information

### **Table 3. Ordering information**

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BT258-600R	TO220	BT258-600R,127	Tube	50	SOT78	13-Jun-2008

## 7. Marking

#### Table 4. Marking codes

Type number	Marking codes				
	Assembly factory: d	Assembly factory: A			
BT258-600R	BT258 600R PJdxxxx xx	BT258 600R PJAxxxx xx			

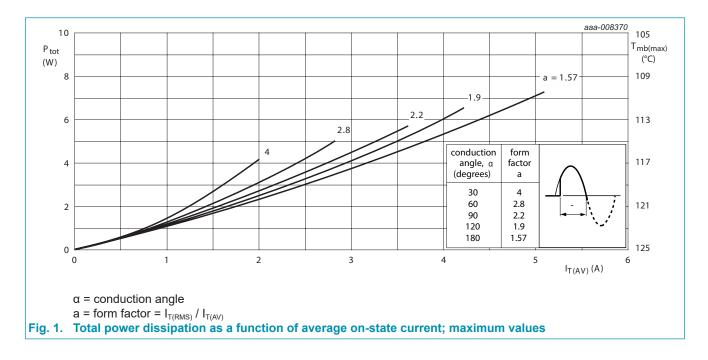
# 8. Limiting values

**Table 5. Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage			-	600	V
$V_{RRM}$	repetitive peak reverse voltage			-	600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>mb</sub> ≤ 111 °C; <u>Fig. 1</u>		-	5	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>mb</sub> ≤ 111 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	8	Α
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5		-	75	А
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		-	82	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; SIN		-	28	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	$I_T = 10 \text{ A}; I_G = 50 \text{ mA}; dI_G/dt = 50 \text{ mA/}\mu\text{s}$		-	50	A/µs
I <sub>GM</sub>	peak gate current			-	2	Α
$V_{RGM}$	peak reverse gate voltage			-	5	V
$P_{GM}$	peak gate power			-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period		-	0.5	W
T <sub>stg</sub>	storage temperature			-40	150	°C
T <sub>j</sub>	junction temperature		[1]	-	125	°C

[1] Operation above 110°C may require the use of a gate to cathode resistor of  $1k\Omega$  or less.



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**Logic level thyristor** 

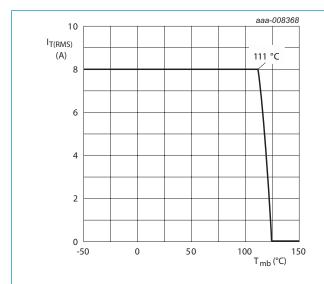
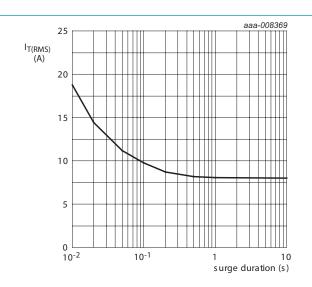
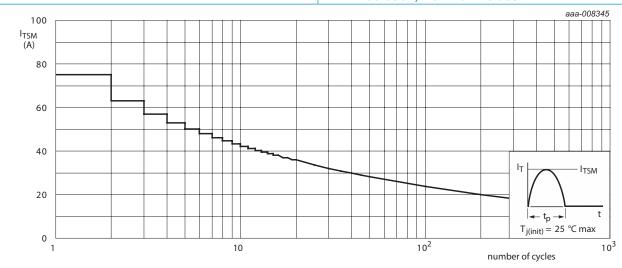


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values



f = 50 Hz; T<sub>mb</sub> =111 °C Fig. 3. RMS on-state current as a function of surge duration; maximum values

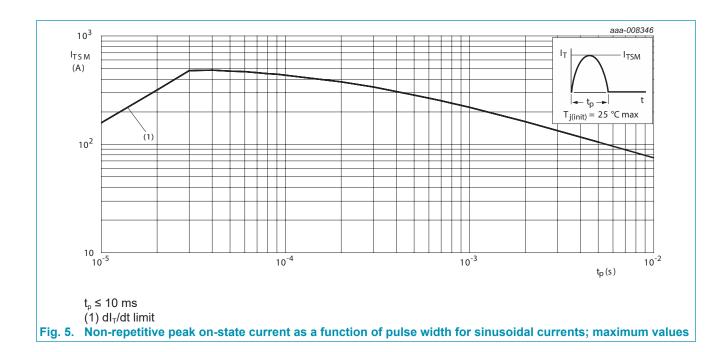


f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	Fig. 6	-	-	2	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

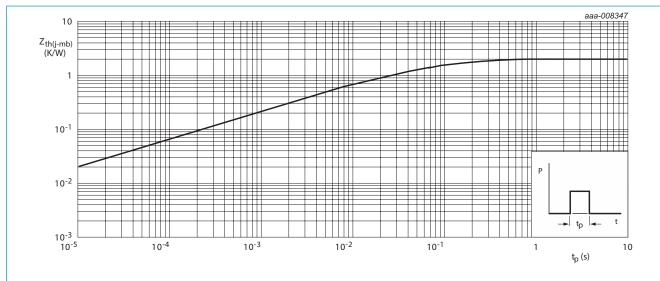


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics			'	•	
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$	-	50	200	mA
I <sub>L</sub>	latching current	V <sub>D</sub> = 12 V; I <sub>G</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	0.4	10	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	0.4	6	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 16 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
$V_{GT}$	gate trigger voltage	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A;T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	-	0.4	1	V
		V <sub>D</sub> = 600V; I <sub>T</sub> = 0.1 A;T <sub>j</sub> = 110 °C	0.1	0.2	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 600 V; T <sub>j</sub> = 125 °C	-	0.1	0.5	mA
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 125 °C	-	0.1	0.5	mA
Dynamic	characteristics			'		1
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $R_{GK}$ = 100 Ω; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 12	50	100	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 10 \text{ A}; V_D = 600 \text{ V}; I_G = 5 \text{ mA};$ $dI_G/dt = 0.2 \text{ A/µs}; T_J = 25 ^{\circ}\text{C}$	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$V_{DM} = 402 \text{ V; } T_j = 125 \text{ °C; } I_{TM} = 12 \text{ A; } V_R = 24 \text{ V; } (dI_T/dt)_M = 10 \text{ A/µs; } dV_D/dt = 2 \text{ V/µs; } R_{GK(ext)} = 1 \text{ k}\Omega; (V_{DM} = 67\% \text{ of } V_{DRM})$	-	100	-	μs

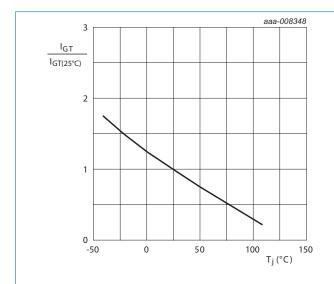


Fig. 7. Normalized gate trigger current as a function of junction temperature

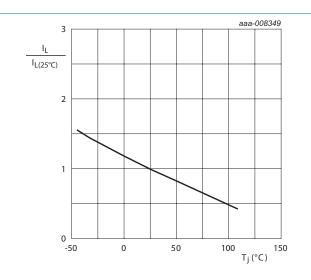


Fig. 8. Normalized latching current as a function of junction temperature

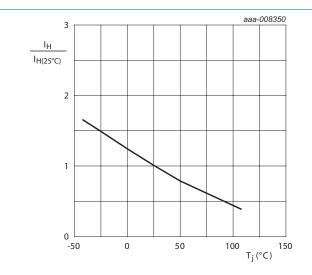
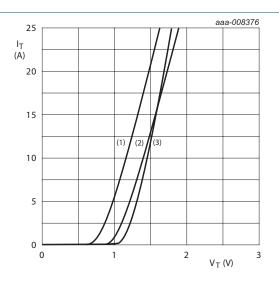


Fig. 9. Normalized holding current as a function of junction temperature



 $V_0$  = 1.0 V;  $R_s$  = 0.04 Ω (1)  $T_j$  = 125 °C; typical values (2)  $T_j$  = 125 °C; maximum values (3)  $T_j$  = 25 °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

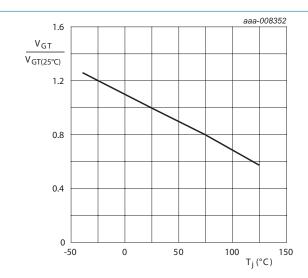
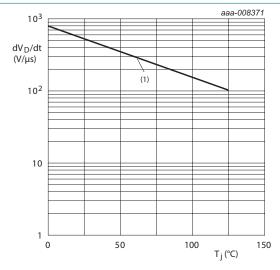


Fig. 11. Normalized gate trigger voltage as a function of junction temperature



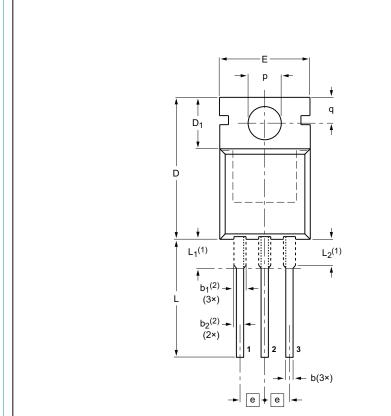
(1)  $R_{GK} = 100 \Omega$ 

Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

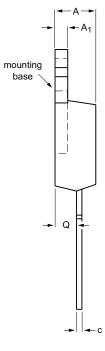
SOT78

## 11. Package outline

Assembly factory: d & A



Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB



0 5 10 mm scale

#### **DIMENSIONS** (mm are the original dimensions)

		•		-		•										
UNIT	Α	A <sub>1</sub>	b	b <sub>1</sub> <sup>(2)</sup>	b <sub>2</sub> (2)	С	D	D <sub>1</sub>	E	е	L	L <sub>1</sub> (1)	L <sub>2</sub> <sup>(1)</sup> max.	р	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

#### Notes

- Lead shoulder designs may vary.
   Dimension includes excess dambar.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT78		3-lead TO-220AB	SC-46		<del>08-04-23</del> 08-06-13

BT258-600R

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Logic level thyristor

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## BT258-600R

### **Logic level thyristor**

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